

# APPROVAL SHEET

# MA04X, MA06X

±1%, ±5%, Convex Type

Thick Film Chip Resistors Array

Size 0402x4, 0603x4 (8p4R) (Automotive & Anti-sulfur)

RoHS 2 Compliant with exemption 7C-1 Halogen free

\*Contents in this sheet are subject to change without prior notice.

### **FEATURE**

- 1. High reliability and stability
- 2. Sulfuration resistant ASTM B-809 60'C 500hrs
- 3. Automotive grade with AEC Q-200 compliant
- 4. Higher component and equipment reliability
- 5. RoHS 2 compliant with exemption 7C-1 and Halogen free products
- 6. Thick film chip resistors array

#### APPLICATION

- · Consumer electrical equipment
- EDP, Computer application
- Telecom
- Automotive application

## **DESCRIPTION**

The resistors array is constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (Pb free) solder alloy.

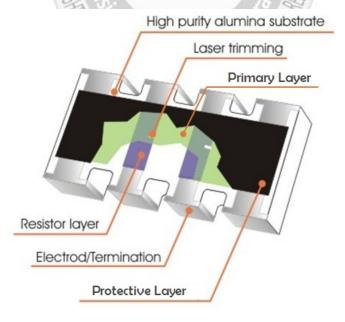


Fig 1. Consctruction of a Chip-R array(convex Type)

# **QUICK REFERENCE DATA**

| Item                                       | General           | Specification                       |
|--|-------------------|-------------------------------------|
| Series No.                                 | MA04X             | MA06X                               |
| Size                                       | 0402x4 (1005x4)   | 0603x4 (1608x4)                     |
| Termination construction                   | Convex            | Convex                              |
| Resistance Tolerance                       | ±5%, ±1%          | ±5%, ±1%                            |
| Resistance Range                           | 10Ω ~ 1MΩ, Jumper | 10 $\Omega$ ~ 1M $\Omega$ , Jumper, |
| TCR (ppm/°C)                               | ≤ ± 300           | ≤ ± 200                             |
| Max. dissipation at T <sub>amb</sub> =70°C | 1/16 W            | 1/10 W                              |
| Max. Operation Voltage                     | 25V               | 50V                                 |
| Max. overload voltage                      | 50V               | 100V                                |
| Insulation Resistance                      | 50V               | 100V                                |
| Operation temperature -55 ~ +155°C         |                   |                                     |

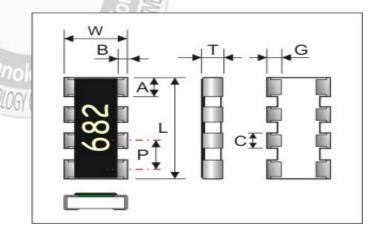
#### Note:

- 1. Climatic category refer to IEC 60068
- 2. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
- 3. Max. Operation Voltage: So called RCWV (Rated Continuous Working Voltage) is determined by

 $RCWV = \sqrt{Rated Power \times Resistance Value}$  or Max. RCWV listed above, whichever is lower.

# **DIMENSIONS** (unit: mm)

| MA04X                    | MA06X   |  |  |
|--------------------------|---|--|--|
| 2.00 ± 0.10              | 3.20 ± 0.10   |  |  |
| 1.00 ± 0.10              | 1.60 ± 0.10   |  |  |
| 0.45 ± 0.10              | 0.50 ± 0.10   |  |  |
| 0.50 ± 0.05              | 0.80 ± 0.10   |  |  |
| <b>A</b> 0.40 ± 0.10 0.6 |   |  |  |
| 0.20 ± 0.10              | 0.30 ± 0.10   |  |  |
| $0.30 \pm 0.05$          | 0.40 ± 0.10   |  |  |
| <b>G</b> 0.25 ± 0.10 0.3 |   |  |  |
|                          | $2.00 \pm 0.10$ $1.00 \pm 0.10$ $0.45 \pm 0.10$ $0.50 \pm 0.05$ $0.40 \pm 0.10$ $0.20 \pm 0.10$ $0.30 \pm 0.05$ |  |  |



### **MARKING**

3-digits marking for E24 series  $\pm 1\%$ ,  $\pm 5\%$  products.

No marking for chip resistors array E96 series resistance.

Each resistor is marked with a three digits code on the protective coating to designate the nominal resistance value.

### **Example**

| Resistance   | 10Ω | 100Ω | 6800Ω | 47000Ω |
|--------------|-----|------|-------|--------|
| Marking code | 100 | 101  | 682   | 473    |

### **FUNCTIONAL DESCRIPTION**

#### Product characterization

Standard values of nominal resistance are taken from the E24 series for resistors with a tolerance of  $\pm 5\%$ , The values of the E24 series are in accordance with "IEC publication 60063"

Standard values of nominal resistance are taken from the E24/E96 series for resistors with a tolerance of  $\pm 1\%$ , The values of the E24/E96 series are in accordance with "IEC publication 60063"

# **Derating**

The power that the resistor can dissipate depends on the operating temperature; see Fig.2.

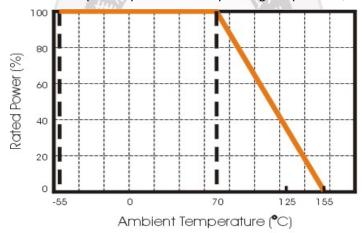
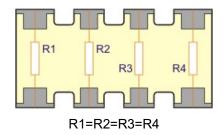


Fig.2 Maximum dissipation in percentage of rated power As a function of the ambient temperature

## **CONSTRUCTION**



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### **SOLDERING CONDITION follow J-STD-020D**

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

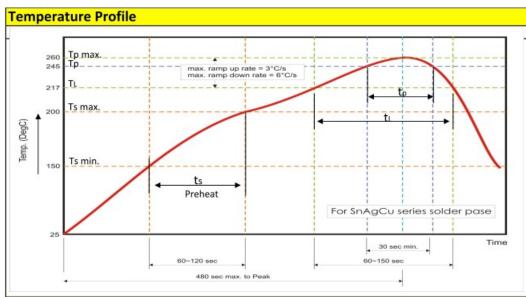


Fig 3. Infrared soldering profile for Chip Resistors array

### **CATALOGUE NUMBERS**

The resistors have a catalogue number starting with .

| MA04            | х          | 472_   | J          | Т                     | L             |
|-----------------|------------|--|------------|-----------------------|---------------|
| Automotive code | Type code  | Resistance code  | Tolerance  | Packaging code        | Special code  |
|                 | X : Convex | - ,  | F:±1%      | T: 7" Reeled taping   | L = Lead free |
| MA04 : 0402 x 4 |            | digits   | J : ±5%    | Q : 10" Reeled taping |               |
| MA06 : 0603 x 4 |            | followed by no. of   | P : Jumper | G : 13" Reeled taping |               |
|                 |            | zeros and a blank  |            | B : Bulk              |               |
|                 |            | 220Ω =221_   |            |                       |               |
|                 |            | ("_" means a blank)  |            |                       |               |
|                 |            | 1%, E24+E96: 3 significant digits followed by no. of zeros |            |                       |               |
|                 |            | 102Ω =1020   |            |                       |               |
|                 |            | 37.4ΚΩ =3742   |            |                       |               |

<sup>\*</sup> Anti-sulfur test conditions: ASTM B-809 60'C, 90% RH, 500 hrs, criteria: within ±1%!

MA06X, Reeled tape packaging: 8mm width paper taping 5000pcs per reel.

MA04X, Reeled tape packaging : 8mm width paper taping 10,000pcs per reel.

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<sup>\* 100%</sup> CCD visual inspection to guarantee visual quality!

## **TEST AND REQUIREMENTS**

Essentially all tests are carried out according to the schedule of IEC publication 115-8, category LCT/UCT/56(rated temperature range: Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days). The testing also meets the requirements specified by EIA, EIAJ and JIS.

The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, subclause 5.3. Unless otherwise specified, the following value supplied:

Temperature: 15°C to 35°C. Relative humidity: 45% to 75%.

Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar). All soldering tests are performed with midly activated flux.

| TEST   | PROCEDURE / TEST METHOD  | REQUIREMENT  |          |  |
|--|--|--|----------|--|
| 1531   | PROCEDURE / TEST METHOD  | Resistor   | 0Ω       |  |
| Electrical Characteristics  JISC5201-1: 1998  Clause 4.8   | - DC resistance values measurement - Temperature Coefficient of Resistance (T.C.R) Natural resistance change per change in degree centigrade. $\frac{R_2-R_1}{R_1(t_2-t_1)}\times 10^6 \; \text{(ppm/°C)}  t_1:20^\circ\text{C}+5^\circ\text{C}-1^\circ\text{C}}$ $R_1: \text{Resistance at reference temperature}$ $R_2: \text{Resistance at test temperature}$ | Within the specified tolerance<br>Refer to "QUICK REFERENCE<br>DATA" |          |  |
| Resistance to soldering heat(R.S.H) MIL-STD-202 method 201 | Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 270°C±5°C  | $\Delta$ R/R max. $\pm$ (0.5%+0.05 $\Omega$ )                        | <50mΩ    |  |
| Solderability J-STD-202                                    | <ul> <li>a) Bake the sample for 155°C dwell time 4hrs/ solder dipping 235°C/ 5sec.</li> <li>b) Steam the sample dwell time 1 hour/ solder dipping 260°C/ 7sec.</li> </ul>  | 95% coverage min., good tinning visible damage                       | g and no |  |
| Temperature cycling JESD22 method JA-104                   | 1000 cycles, -55°C ~ +155°C, dwell time 5~10min  | $\Delta$ R/R max. $\pm$ (0.5%+0.05 $\Omega$ )                        | < 50mΩ   |  |
| Moisture Resistance<br>MIL-STD-202<br>method 106           | 65±2°C, 80~100% RH, 10 cycles, 24 hours/ cycle   | $\Delta$ R/R max. $\pm$ (0.5%+0.10 $\Omega$ )                        | < 50mΩ   |  |
| Bias Humidity MIL-STD-202 method 103                       | 1000+48/-0 hours; 85°C, 85% RH, 10% of operation power   | $\Delta$ R/R max. $\pm$ (1.0%+0.05 $\Omega$ )<br>No visible damage   | <50mΩ    |  |
| Operational Life MIL-STD-202 method 108                    | 1000+48/-0 hours; 35% of operation power, 125±2°C  | $\Delta$ R/R max. $\pm$ (1.0%+0.05 $\Omega$ )<br>No visible damage   | < 50mΩ   |  |
| High Temperature Exposure MIL-STD-202 method 108           | 1000+48/-0 hours; without load in a temperature chamber controlled 155±3°C   | $\Delta$ R/R max. $\pm$ (1.0%+0.05 $\Omega$ )<br>No visible damage   | <50mΩ    |  |

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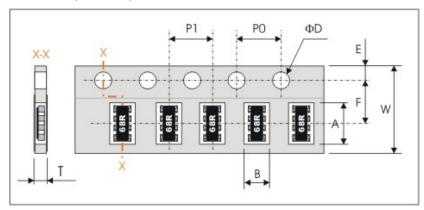
| TEST                | PROCEDURE / TEST METHOD  | REQUIREMENT                                   |            |  |
|---------------------|--|---|------------|--|
| 1531                | PROCEDURE / TEST METHOD  | Resistor                                      | 0Ω         |  |
| Board Flex          | Resistors mounted on a 90mm glass epoxy resin  | $\Delta$ R/R max. ±(1.0%+0.05Ω).              |            |  |
| AEC-Q200-005        | PCB(FR4),  | No visible damage                             | <50mΩ      |  |
|                     | bending once 2mm for 10sec   |   |            |  |
| Terminal strength   | Pressurizing force: 1Kg, Test time: 60±1sec.   | No remarkable damage or remo                  | val of the |  |
| AEC-Q200-006        |  | terminations                                  |            |  |
| Vibration           | Test 5g's for 20min., 12 cycles each of 3 orientations   | $\Delta$ R/R max. ±(1.0%+0.05Ω)               |            |  |
| MIL-STD-202         |  | No visible damage                             | <50mΩ      |  |
| method 204          |  |   |            |  |
| Thermal shock       | Test –55 to 155°C / dwell time 15min/ Max transfer time  | $\Delta$ R/R max. $\pm$ (0.5%+0.05 $\Omega$ ) |            |  |
| MIL-STD-202         | 20sec, 300cycles   | No visible damage                             | <50mΩ      |  |
| method 107          |  |   |            |  |
| ESD                 | Test contact 1.0KV   | $\Delta$ R/R max. ±(1.0%+0.05Ω)               | <50mΩ      |  |
| AEC-Q200-002        | 45 0   | No visible damage                             | <5011102   |  |
| Short Time Overload | 2.5 times RCWV or max. overload voltage, for   | ±5%: ΔR/R max. ±(2%+0.05Ω)                    |            |  |
| (STOL)              | 5seconds   | ±1%: ΔR/R max. ±(1%+0.05Ω)                    | <50mΩ      |  |
| JISC5201-1: 1998    | AND THE STATE OF T | No visible damage                             | 3011152    |  |
| Clause 4.13         | W 30   |   |            |  |
| Sulfuration test    | ASTM B-809 -95 60'C , 90% RH. 500hrs   | $\Delta$ R/R max. $\pm$ (1.0%+0.05 $\Omega$ ) | <50mΩ      |  |
| ASTM B-809-95       | ASTM B-809-95  |   | ~5011I22   |  |

# TEST CONDITION FOR JUMPER (0 $\Omega$ )

| Item                  | MA04X       | MA06X       |  |
|-----------------------|-------------|-------------|--|
| Power Rating At 70°C  | 1/16W       | 1/10W       |  |
| Resistance            | MAX.50m $Ω$ | MAX.50m $Ω$ |  |
| Rated Current         | 1A          | 1A          |  |
| Peak Current          | 1.5A        | 3A          |  |
| Operating Temperature | -55~155°C   | -55~155°C   |  |

# **PACKAGING**

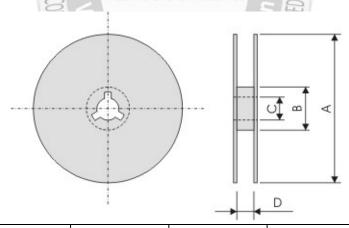
# Paper Tape specifications (unit :mm)



| Symbol | А         | В         | W         | F         | Е         |
|--------|-----------|-----------|-----------|-----------|-----------|
| MA06X  | 3.60±0.20 | 2.00±0.20 | 8.00+0.30 | 3.50+0.20 | 1.75±0.10 |
| MA04X  | 2.20±0.20 | 1.20±0.20 | 6.00±0.30 | 3.50±0.20 | 1.75±0.10 |

| Symbol | P1        | P0        | ΦD                                    | Т        |
|--------|-----------|-----------|---------------------------------------|----------|
| MA06X  | 4.00±0.10 | 4.00±0.10 | <b>⊅</b> 4 <b>E</b> 0+0.1             | Max. 1.0 |
| MA04X  | 2.00±0.05 | 4.00±0.10 | Φ1.50 <sup>+0.1</sup> <sub>-0.0</sub> | Max. 0.6 |

# Reel dimensions



| Symbol      | Α          | В         | С        | D       |
|-------------|------------|-----------|----------|---------|
| MA06X,MA04X | Φ178.0±2.0 | Φ60.0±1.0 | 13.0±0.2 | 9.0±0.5 |

# 单击下面可查看定价,库存,交付和生命周期等信息

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